

SANYO Semiconductors DATA SHEET

MOSFET: N-Channel Silicon MOSFET

SBD: Schottky Barrier Diode

SCH2821 — General-Purpose Switching Device Applications

Features

- Composite type with an N-channel silicon MOSFET and a schottky barrier diode contained in one package facilitating high-density mounting.
- · [MOSFET]
 - · Low ON-resistance.
 - · Ultrahigh-speed switching.
 - 4V drive.
- · [SBD]
 - · Short reverse recovery time.
 - · Low forward voltage.

Specifications

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
[MOSFET]				
Drain-to-Source Voltage	VDSS		20	V
Gate-to-Source Voltage	VGSS		±12	V
Drain Current (DC)	ID		1.6	Α
Drain Current (Pulse)	IDP	PW≤10μs, duty cycle≤1%	6.4	Α
Allowable Power Dissipation	PD	Mounted on a ceramic board (900mm²X0.8mm) 1unit	0.6	W
Channel Temperature	Tch		150	°C
Storage Temperature	Tstg		-55 to +125	°C
[SBD]				
Repetitive Peak Reverse Voltage	VRRM		15	V
Nonrepetitive Peak Reverse Surge Voltage	VRSM		15	V
Average Output Current	lo		0.5	Α
Surge Forward Current	IFSM	50Hz sine wave, 1 cycle	3	Α
Junction Temperature	Tj		-55 to +125	°C
Storage Temperature	Tstg		-55 to +125	°C

Marking: QW

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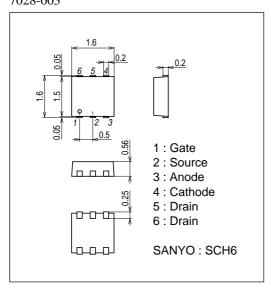
SCH2821

Electrical Characteristics at Ta=25°C

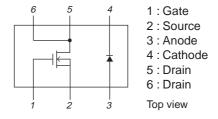
Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	Unit
[MOSFET]						
Drain-to-Source Breakdown Voltage	V(BR)DSS	ID=1mA, VGS=0V	20			V
Zero-Gate Voltage Drain Current	IDSS	V _{DS} =20V, V _{GS} =0V			1	μΑ
Gate-to-Source Leakage Current	IGSS	V _{GS} =±9.6V, V _{DS} =0V			±10	μΑ
Cutoff Voltage	VGS(off)	V _{DS} =10V, I _D =1mA	1.2		2.6	V
Forward Transfer Admittance	yfs	V _{DS} =10V, I _D =800mA	0.9	1.5		S
Static Drain-to-Source On-State Resistance	R _{DS} (on)1	I _D =800mA, V _{GS} =10V		90	120	mΩ
	R _{DS} (on)2	I _D =400mA, V _G S=4.5V		130	185	mΩ
	RDS(on)3	ID=400mA, VGS=4V		145	210	mΩ
Input Capacitance	Ciss	V _{DS} =10V, f=1MHz		158		pF
Output Capacitance	Coss	V _{DS} =10V, f=1MHz		36		pF
Reverse Transfer Capacitance	Crss	V _{DS} =10V, f=1MHz		27		pF
Turn-ON Delay Time	t _d (on)	See specified Test Circuit.		6.6		ns
Rise Time	t _r	See specified Test Circuit.		9.8		ns
Turn-OFF Delay Time	t _d (off)	See specified Test Circuit.		24.5		ns
Fall Time	tf	See specified Test Circuit.		10		ns
Total Gate Charge	Qg	V _{DS} =10V, V _{GS} =10V, I _D =1.6A		4.9		nC
Gate-to-Source Charge	Qgs	V _{DS} =10V, V _{GS} =10V, I _D =1.6A		0.61		nC
Gate-to-Drain "Miller" Charge	Qgd	V _{DS} =10V, V _{GS} =10V, I _D =1.6A		0.74		nC
Diode Forward Voltage	V _{SD}	I _S =1.6A, V _{GS} =0V		0.81	1.2	V
[SBD]	•			•		
Reverse Voltage	٧R	I _R =0.5mA	15			V
Forward Voltage	٧F	IF=0.5A		0.4	0.46	V
Reverse Current	IR	V _R =6V			90	μΑ
Interterminal Capacitance	С	V _R =10V, f=1MHz		13		pF
Reverse Recovery Time	t _{rr}	I _F =I _R =100mA, See specified Test Circuit.			10	ns

Package Dimensions

unit : mm 7028-003

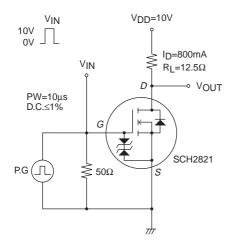


Electrical Connection



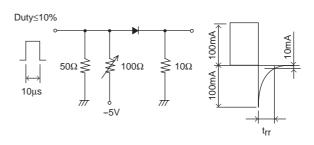
Switching Time Test Circuit

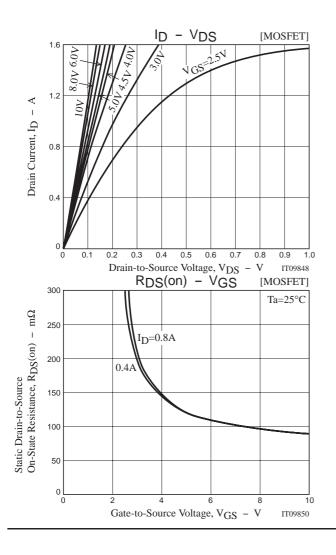
[MOSFET]

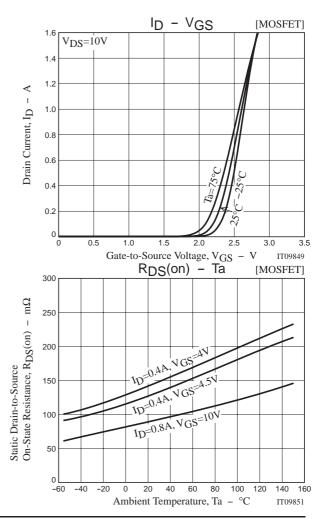


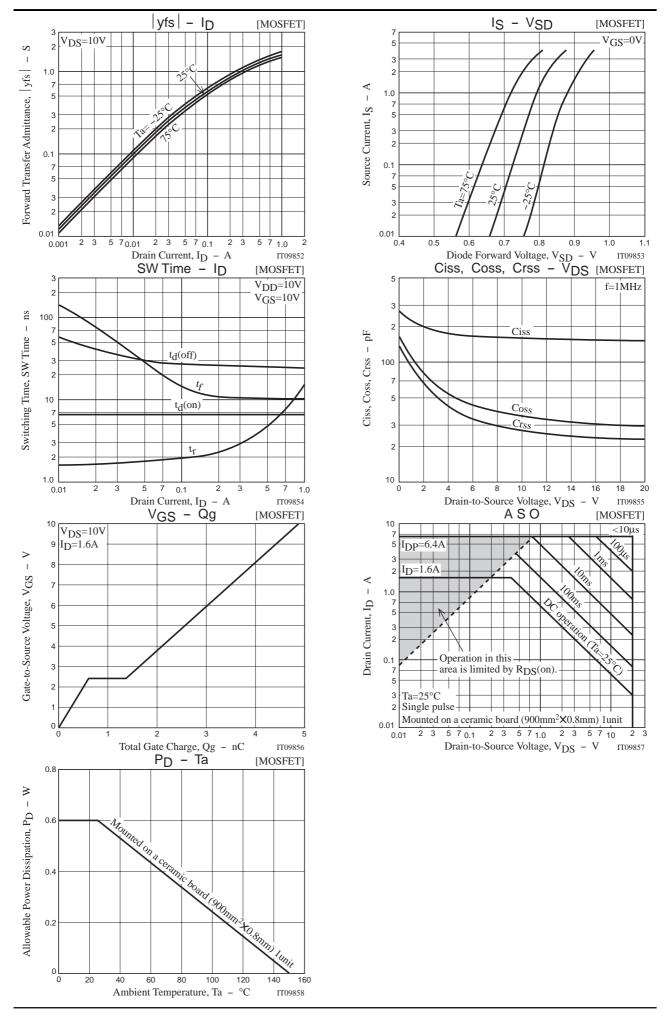
trr Test Circuit

[SBD]

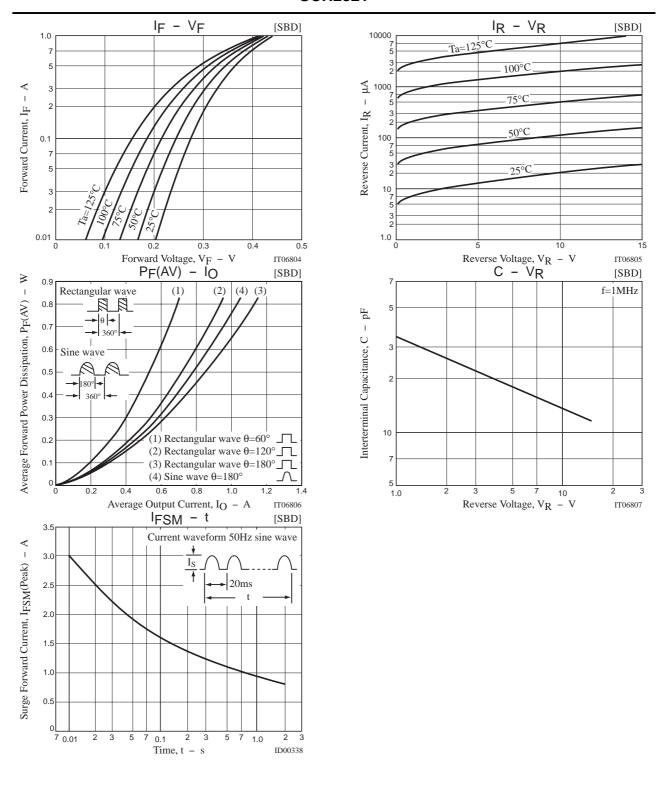








SCH2821



Note on usage: Since the SCH2821 is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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